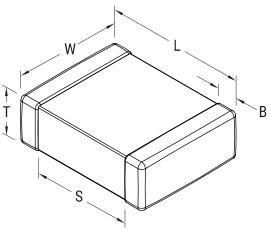


C1206S472K5RACTU

Aliases (C1206S472K5RAC7800)

SMD Comm X7R FE, Ceramic, 4,700 pF, 10%, 50 VDC, X7R, SMD, MLCC, FE-CAP, Floating Electrode, Temperature Stable, 1206, 1.5 mm



S		Termination
		Marking
	S	AEC-Q200
	Typical Component Weight	
	Click here for the 3D model.	Shelf Life
		MSL
Dimensions		Specifications
Chip Size	1206	Capacitance
L	3.2mm +/-0.2mm	Measurement Condition
W	1.6mm +/-0.2mm	Tolerance

0.78mm +/-0.10mm

0.5mm +/-0.25mm

1.5mm MIN

Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	4000

Т

S

В

General Information	
Series	SMD Comm X7R FE
Style	SMD Chip
Description	SMD, MLCC, FE-CAP, Floating Electrode, Temperature Stable
Features	FE-CAP, Floating Electrode, Temperature Stable
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	17 mg
Shelf Life	78 Weeks
MSL	1

Specifications	
Capacitance	4,700 pF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	10%
Voltage DC	50 VDC
Dielectric Withstanding Voltage	125 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
Dissipation Factor	2.5% 1 kHz 1.0Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	100 GOhms

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